



SPECIFICATION (Reference sheet)

- Supplier : Samsung electro-mechanics
- Product : Multi-layer Ceramic Capacitor
- Samsung P/N : CL05A224KP5NNNC
- Description :
- CAP, 220nF, 10V, ±10%, X5R, 0402

A. Samsung Part Number

			<u>CL</u>	<u>05</u>	<u>A</u>	<u>224</u>	<u>K</u>	<u>P</u>	<u>5</u>	<u>N</u>	<u>N</u>	<u>N</u>	<u>C</u>	
			1	2	3	4	5	6		8	9	10	1	
(1) Se	ries	Samsun	a Multi	-laver	Cera	amic (lana	citor						
② Siz			(inch c	-	Cort		-	± 0.0)5	mm		W:	0.5 ± 0.05 mm	
	- lo otrio							luura					Ni	
-	electric	X5R	_				(8)	-		ctrode			Ni	
	pacitance	220						Tern		lion			Cu	
5 Ca	pacitance	±10	%					Plati	ng				Sn 100% (Pb Free)	
tol	erance						9	Proc	luct				Normal	
6 Ra	ted Voltage	10	V				10	Spee	cial				Reserved for future use	
⑦ Th	ickness	0.5	± 0.05	mm			1	Pack	cagir	ng			Cardboard Type, 7" reel	

B. Samsung Reliability Test and Judgement condition

	Performance	Test condition					
Capacitance	Within specified tolerance	1kl±10% 1.0±0.2Vrms					
Tan δ (DF)	0.05 max.						
Insulation	10,000Mohm or 100Mohm·µF	Rated Voltage 60~120 sec.					
Resistance	Whichever is Smaller						
Appearance	No abnormal exterior appearance	Visual inspection					
Withstanding	No dielectric breakdown or	250% of the rated voltage					
Voltage	mechanical breakdown						
Temperature	X5R						
Characteristics	(From -55 \degree to 85 \degree , Capacitance change should be within ±15%)						
Adhesive Strength	No peeling shall be occur on the	500g·F, for 10±1 sec.					
of Termination	terminal electrode						
Bending Strength	Capacitance change : within ±12.5%	Bending to the limit (1mm)					
		with 1.0mm/sec.					
Solderability	More than 75% of terminal surface	SnAg3.0Cu0.5 solder					
	is to be soldered newly	245±5℃, 3±0.3sec.					
		(preheating : 80~120 ℃ for 10~30sec.)					
Resistance to	Capacitance change : within ±7.5%	Solder pot : 270±5℃, 10±1sec.					
Soldering heat	Tan δ, IR : initial spec.						

	Performance	Test condition					
Vibration Test	Capacitance change : within ±5%	Amplitude : 1.5mm					
	Tan δ, IR : initial spec.	From 10Hz to 55Hz (return : 1min.)					
		2hours \times 3 direction (x, y, z)					
Moisture	Capacitance change : within ±12.5%	With rated voltage					
Resistance	Tan δ: 0.075 max	40±2℃, 90~95%RH, 500+12/-0 hours					
	IR : 500Mohm or 25Mohm · µF						
	Whichever is Smaller						
High Temperature	Capacitance change : within ±12.5%	With 200% of the rated voltage					
Resistance	Tan δ: 0.075 max	Max. operating temperature					
	IR : 1000Mohm or 50Mohm · μF						
	Whichever is Smaller	1000+48/-0 hours					
Temperature	Capacitance change : within ±7.5%	1 cycle condition					
Cycling	Tan δ, IR : initial spec.	Min. operating temperature \rightarrow 25 °C					
		$ ightarrow$ Max. operating temperature $ ightarrow$ 25 $^\circ\!$					
		5 cycles test					

C. Recommended Soldering method :

Reflow (Reflow Peak Temperature : 260+0/-5°C, 10sec. Max)

Product specifications included in the specifications are effective as of March 1, 2013. Please be advised that they are standard product specifications for reference only. We may change, modify or discontinue the product specifications without notice at any time. So, you need to approve the product specifications before placing an order. Should you have any question regarding the product specifications, please contact our sales personnel or application engineers.